

Cree® XLamp® XP-G LEDs



PRODUCT DESCRIPTION

The XLamp XP-G LED delivers unprecedented levels of light output and efficacy for a single die LED. The XLamp XP-G LED continues Cree’s history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

XLamp XP-G LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED light bulbs, outdoor lighting, portable lighting, indoor lighting and solar-powered lighting.

FEATURES

- Available in white, outdoor white and 80-CRI, 85-CRI and 90-CRI white
- ANSI-compatible chromaticity bins
- Maximum drive current: 1500 mA
- Low thermal resistance: 4 °C/W
- Wide viewing angle: 125°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable - JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS- and REACH-compliant
- UL-recognized component (E349212)



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FLUX CHARACTERISTICS (T_j = 25 °C)

The following table provides several base order codes for XLamp XP-G LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family.

Color	CCT Range		Base Order Codes Min. Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (lm)*			Order Code
	Min.	Max.	Group	Flux (lm)	700 mA	1.0 A	1.5 A	
Cool White	5000 K	8300 K	R3	122	228	305	406	XPGWHT-L1-0000-00F51
			R4	130	243	325	433	XPGWHT-L1-0000-00G51
			R5	139	260	348	463	XPGWHT-L1-0000-00H51
Outdoor White	3200 K	5300 K	R2	114	213	285	380	XPGWHT-01-0000-00EC2
			R3	122	228	305	406	XPGWHT-01-0000-00FC2
			R4	130	243	325	433	XPGWHT-01-0000-00GC2
Neutral White	3700 K	5300 K	Q5	107	200	268	356	XPGWHT-L1-0000-00DE4
			R2	114	213	285	380	XPGWHT-L1-0000-00EE4
			R3	122	228	305	406	XPGWHT-L1-0000-00FE4
80-CRI White	2600 K	4300 K	Q3	93.9	175	235	313	XPGWHT-H1-0000-00BE7
			Q4	100	187	250	333	XPGWHT-H1-0000-00CE7
			Q5	107	200	268	356	XPGWHT-H1-0000-00DE7
Warm White	2600 K	3700 K	Q3	93.9	175	235	313	XPGWHT-L1-0000-00BE7
			Q4	100	187	250	333	XPGWHT-L1-0000-00CE7
			Q5	107	200	268	356	XPGWHT-L1-0000-00DE7
			R2	114	213	285	380	XPGWHT-L1-0000-00EE7
85-CRI White	2600 K	3200 K	P3	73.9	138	185	246	XPGWHT-P1-0000-008E7
			P4	80.6	151	202	268	XPGWHT-P1-0000-009E7
			Q2	87.4	163	219	291	XPGWHT-P1-0000-00AE7
			Q3	93.9	175	235	313	XPGWHT-P1-0000-00BE7
90-CRI White	2600 K	3200 K	P3	73.9	138	185	246	XPGWHT-U1-0000-008E7
			P4	80.6	151	202	268	XPGWHT-U1-0000-009E7
			Q2	87.4	163	219	291	XPGWHT-U1-0000-00AE7

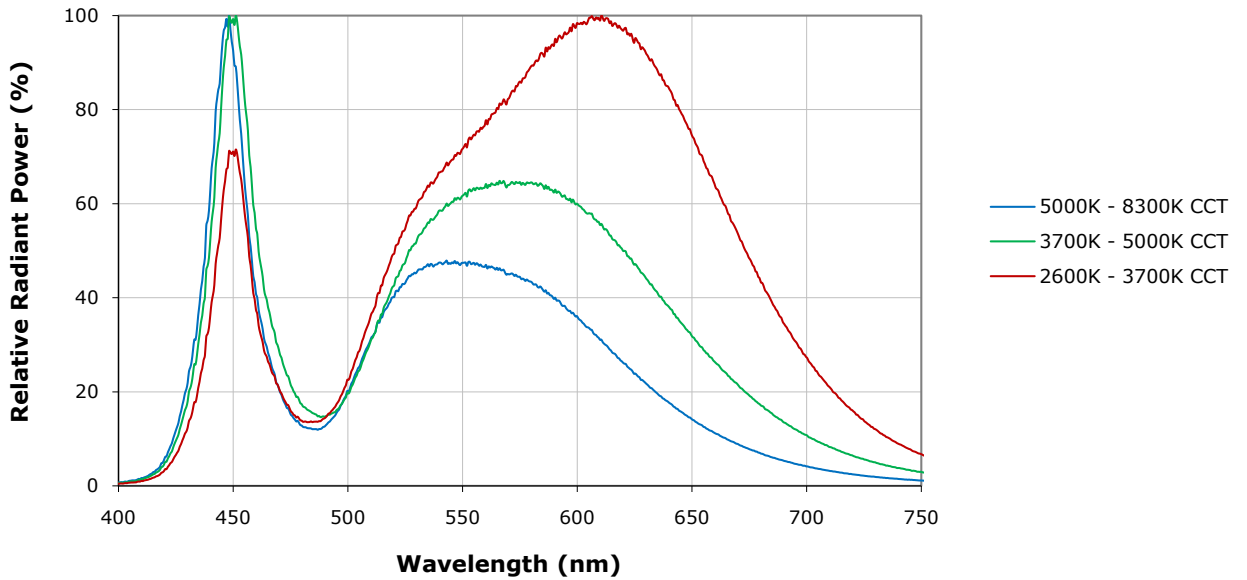
Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CC_x, CC_y) measurements and ± 2 on CRI measurements.
- Typical CRI for Cool White (5000 K - 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K - 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K - 5300 K CCT) is 70.
- Typical CRI for Warm White (2600 K - 3700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.
- Calculated flux values are for reference only.

CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		4	
Viewing angle (FWHM)	degrees		125	
Temperature coefficient of voltage	mV/°C		-2.1	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1500
Reverse voltage	V			5
Forward voltage (@ 350 mA, 25 °C)	V		2.9	3.25
Forward voltage (@ 700 mA, 25 °C)	V		3.05	
Forward voltage (@ 1000 mA, 25 °C)	V		3.15	
Forward voltage (@ 1500 mA, 25 °C)	V		3.25	
LED junction temperature	°C			150

RELATIVE SPECTRAL POWER DISTRIBUTION



RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)

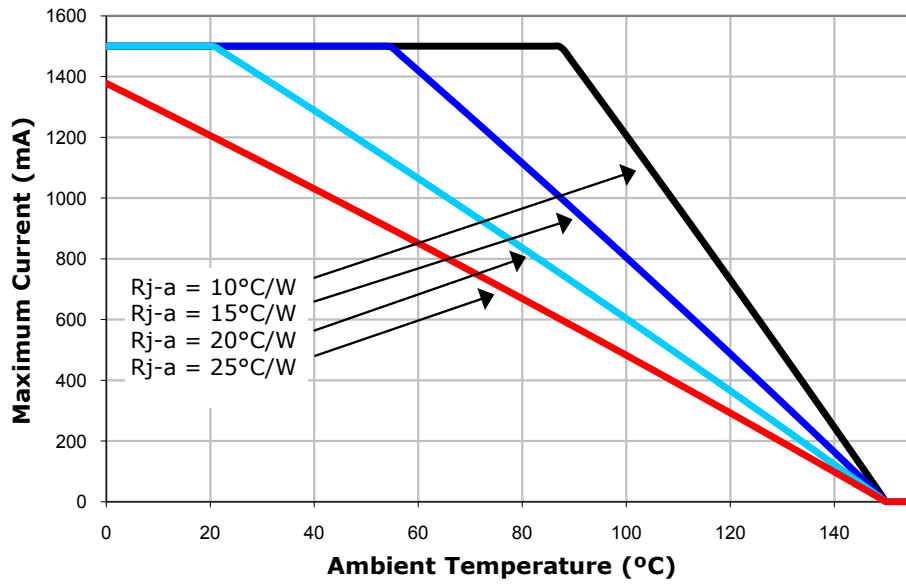


ELECTRICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$)



THERMAL DESIGN

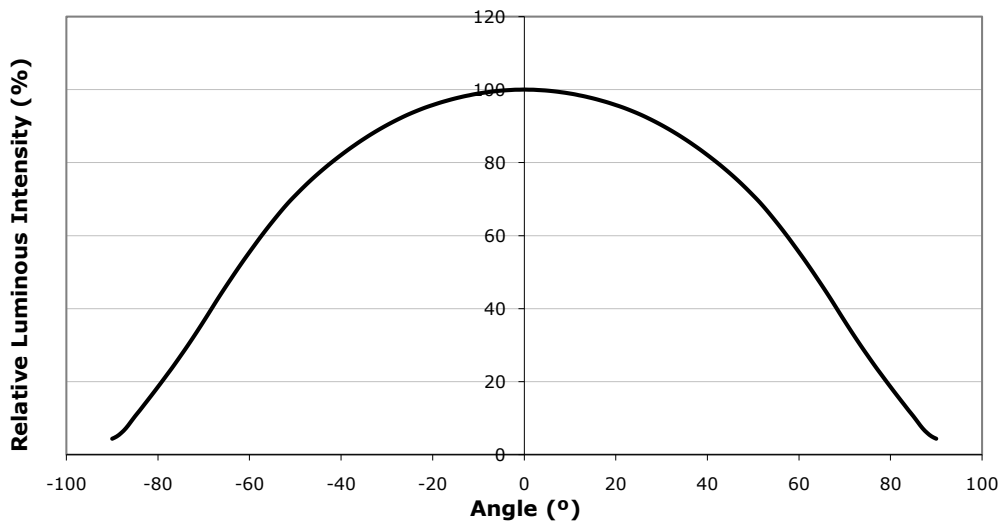
The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



RELATIVE FLUX VS. CURRENT ($T_j = 25\text{ }^\circ\text{C}$)



TYPICAL SPATIAL DISTRIBUTION



RELATIVE CHROMATICITY VS CURRENT AND TEMPERATURE (WARM WHITE*)



* Warm White XLamp XP-G LEDs have a typical CRI of 80

REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-G LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate ($T_{s_{max}}$ to T_P)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min ($T_{s_{min}}$)	100 °C	150 °C
Preheat: Temperature Max ($T_{s_{max}}$)	150 °C	200 °C
Preheat: Time ($t_{s_{min}}$ to $t_{s_{max}}$)	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T_P)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

In testing, Cree has found XLamp XP-G LEDs to have unlimited floor life in conditions ≤ 30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtained from your Cree representative or obtained from the Product Ecology section of www.cree.com.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH Declaration. Historical REACH banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

UL Recognized Component

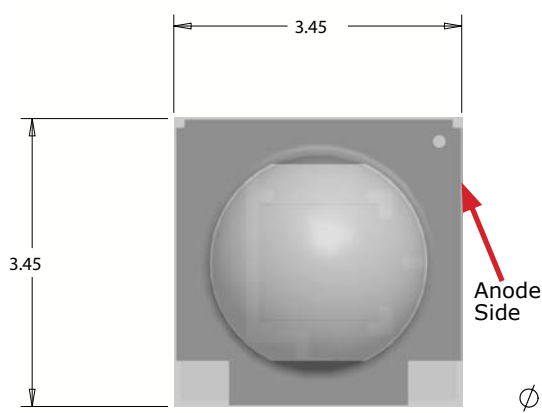
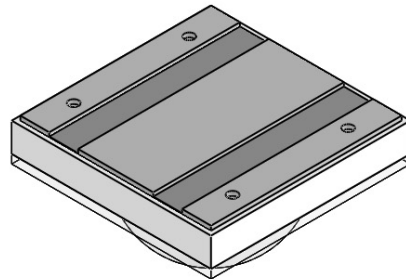
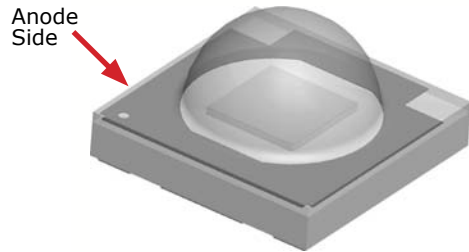
Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory Claim

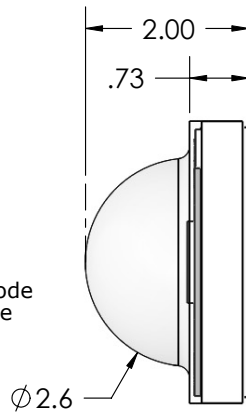
WARNING: Do not look at exposed lamp in operation. Eye injury can result. See LED Eye Safety at www.cree.com/xlamp_app_notes/led_eye_safety.

MECHANICAL DIMENSIONS (T_A = 25 °C)

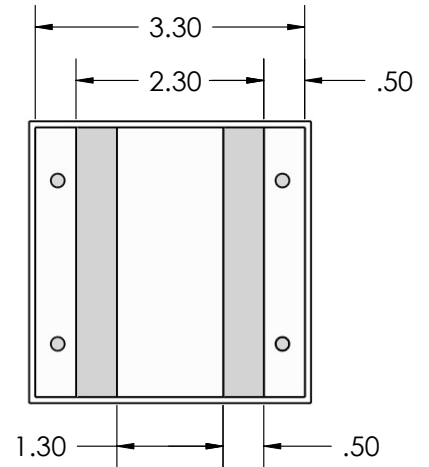
All measurements are ±.13 mm unless otherwise indicated.



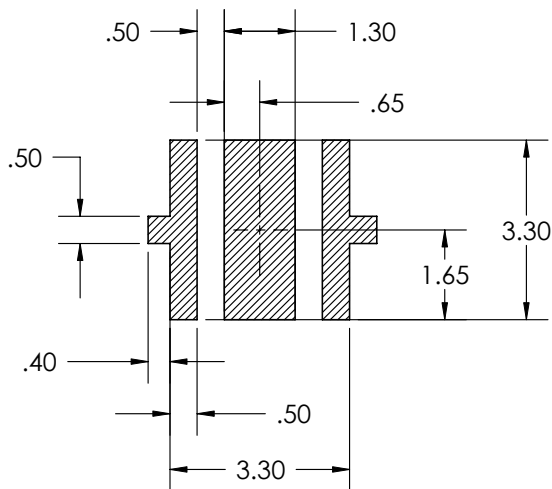
Top View



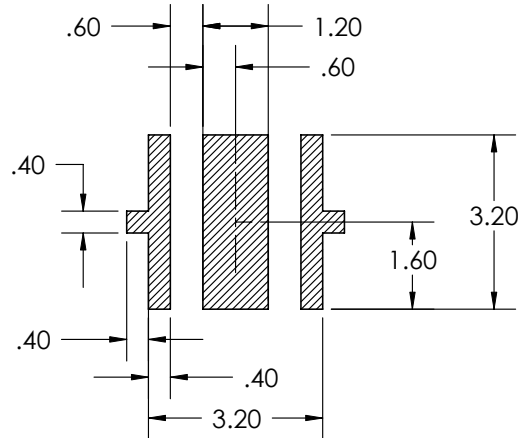
Side View



Bottom View



RECOMMENDED PCB SOLDER PAD

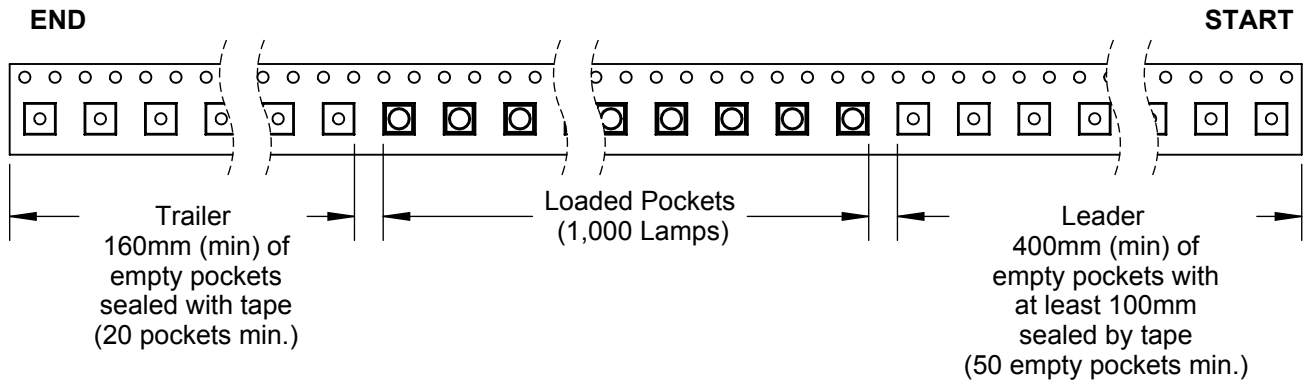


**RECOMMENDED STENCIL PATTERN
(HATCHED AREA IS OPENING)**

TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.



PACKAGING

Unpackaged Reel



Label with Cree Bin Code, Qty, Reel ID

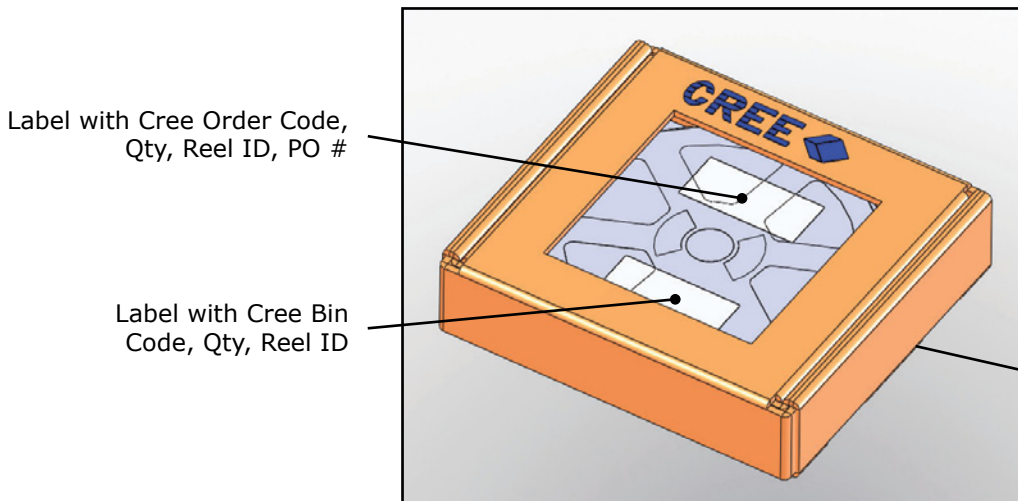
Packaged Reel



Label with Cree Order Code, Qty, Reel ID, PO #

Label with Cree Bin Code, Qty, Reel ID

Boxed Reel



Label with Cree Order Code, Qty, Reel ID, PO #

Label with Cree Bin Code, Qty, Reel ID

Patent Label (on bottom of box)



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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.